# 2SA1534, 2SA1534A

### Silicon PNP epitaxial planer type

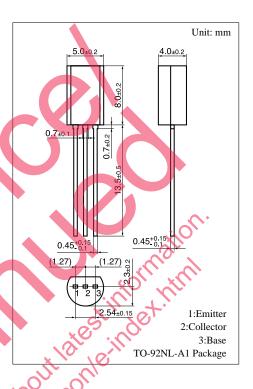
For low-frequency power amplification and driver amplification Complementary to 2SC3940 and 2SC3940A

#### Features

- Complementary pair with 2SC3940 and 2SC3940A.
- Allowing supply with the radial taping and automatic insertion possible.

#### Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to	2SA1534	V	-30	V	
base voltage	2SA1534A	$V_{CBO}$	-60		
Collector to	2SA1534	V	-25	V	
emitter voltage	2SA1534A	$V_{CEO}$	-50	V	
Emitter to base voltage		$V_{\rm EBO}$	-5	V	
Peak collector current		$I_{CP}$	-1.5	A	
Collector current		$I_{\rm C}$	-1	A	
Collector power dissipation		$P_{C}$	1	W	
Junction temperature		$T_j$	150	°C	
Storage temperature		$T_{\rm stg}$	-55 ~ +150	°C	



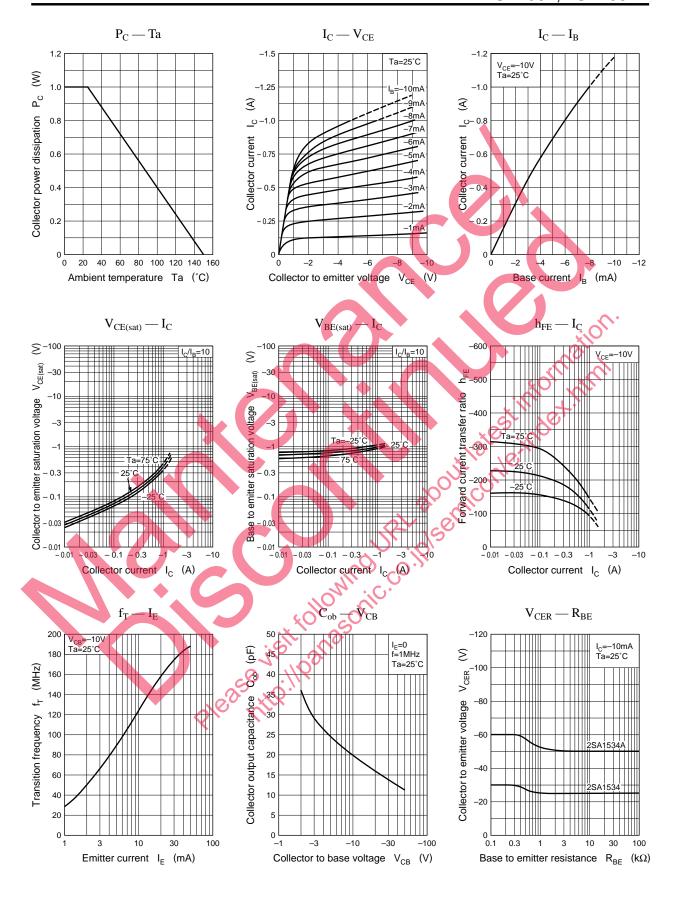
#### Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit	
Collector cutoff current	$I_{CBO}$	$V_{CB} = -20V, I_E = 0$			- 0.1	μА	
Collector to base 2SA1534	V	$I_{C} = -10\mu A$ $I_{C} = 0$	-30			v	
voltage 2SA1534A	$V_{CBO}$	$I_{C} = -10\mu A$ $I_{E} = 0$				V	
Collector to emitter 2SA1534	, J	$I_C = 2mA$ , $I_B = 0$	-25			V	
voltage 2SA1534A	V <sub>CEO</sub>		-50				
Emitter to base voltage	V <sub>EBO</sub>	$I_{\rm E} = -10 \mu A, I_{\rm C} = 0$	-5			V	
Forward current transfer ratio	h <sub>FE1</sub> *	$V_{CE} = -10V, I_{C} = -500mA$	85		340		
Forward current transfer ratio	h <sub>FE2</sub>	$V_{CE} = -5V, I_{C} = -1A$	50				
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -500 \text{mA}, I_{\rm B} = -50 \text{mA}$		- 0.2	- 0.4	V	
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	$I_C = -500 \text{mA}, I_B = -50 \text{mA}$		- 0.85	-1.2	V	
Transition frequency	$f_{\mathrm{T}}$	$V_{CB} = -10V$ , $I_E = 50mA$ , $f = 200MHz$		200		MHz	
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -10V, I_E = 0, f = 1MHz$		20	30	pF	

#### \*h<sub>FE1</sub> Rank classification

Rank	Q	R	S	
h <sub>FE1</sub>	85 ~ 170	120 ~ 240	170 ~ 340	

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